

NOT FOR USE WHERE FAILURE CREATES A HAZARD TO HUMAN HEALTH OR SAFETY. ALL PRODUCTS ARE SUBJECT TO THIS FULL DISCLAIMER: <http://www.ihconnectors.com/disclaimer.html>

REVISION HISTORY			
REV	DESCRIPTION	DATE	APPROVED
2	REDRAWN IN INVENTOR FORMAT	7/1/2011	TDS

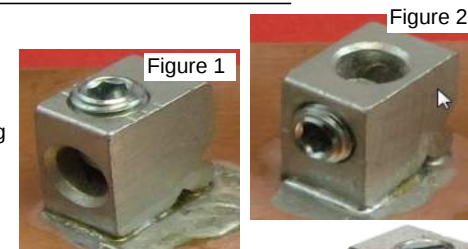
E129884 Vol1 cURus ZMVV2/8 USR/CNR WITH 1/4-28 SLOTTED, 1/8", OR 3mm HEX SKT. SET SCREW ONLY. NOTE THIS PART B6A-PCB-45(-X) IS B6 STYLE 2.

SMT / SMD - SURFACE MOUNTED 90 OR 0

SMT Surface Mount Technology Options:

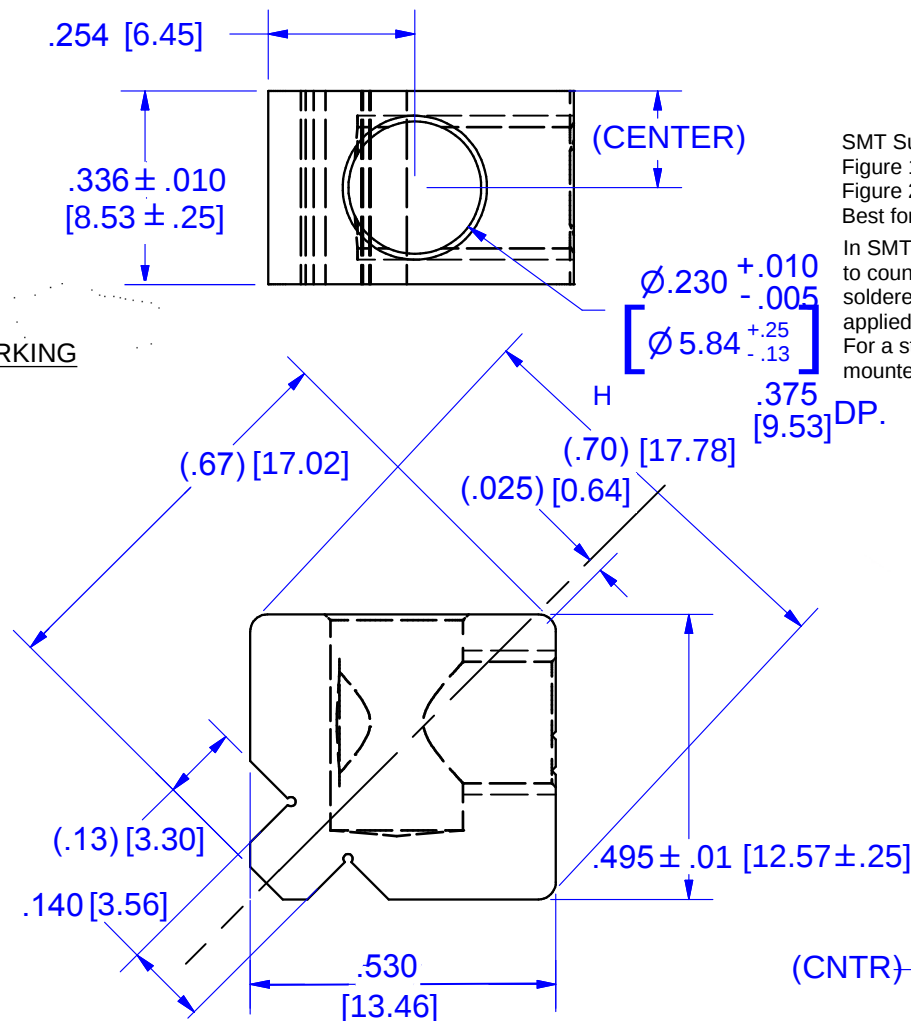
Figure 1: Most Sturdy: Vertical screw and horizontal wire
Figure 2: Least Sturdy: Horizontal screw and vertical wire.
Best for factory wiring only.

In SMT / SMD Mode, use of an open ended wrench on the lug to counter the applied torque is recommended in case the soldered mount to PCB is compromised by excessive torque applied through to the soldered PCB joint.
For a sturdier mounting method use the THT foot and slot mounted 45 degree orientation



MARKING

IHI
B6



1/4-28 UNF - 2B

THT - FOOT & SLOT MOUNTED
45 DEGREE ORIENTATION



HEX SCREW
HEX-M

IHI Connectors
International Hydraulics Inc.
ihconnectors.com



Installation Instructions:
See QR Code

US
ZMVV2, ZMVV8
E129884

6-14 CU7
75°C

Pressure Terminal
Connectors
NRTL Cat. No.
B6

Nominal Wire Strip Length: 0.34in (8.6mm)	
Wire Size	Rated Torque (in-lb)
6 AWG, 10mm ² Str	35
8 AWG, 6mm ² Str	25
10-14 AWG 4-2.5mm ² Sol/Str	20

All Torque in in-lbs. For N-M divide by 8.85.

FOR FURTHER INFORMATION ON THE PROPER USE OF THIS PRODUCT IN SPECIFIC APPLICATIONS SEE: ihconnectors.com/b6.htm

1. B6A-PCB-45-HEX (1/8" HEX SKT. SET SCREW), 3. B6A-PCB-45 (SLOTTED SET SCREW)
2. B6A-PCB-45-HEX-M (3mm HEX SKT. SET SCREW)

USE ABOVE ORDER NUMBERS TO DETERMINE SCREW TYPE

1. SOLDERABLE PCB TERMINAL AWG 6-14 - CONSIDER USE OF FERRULE FOR SMALL OR FINE WIRES. 2. USE WITH STRANDED OR SOLID COPPER WIRE. 3. 1/4-28 SET SCREW WITH EITHER 1/8" th HEX KEY SOCKET OR 3mm HEX KEY SOCKET (SPECIFY). 4. THT FOOT MOUNT (45 DEGREE ORIENTATION) OR SMT / SMD MODE IN 90 / 0 DEGREE ORIENTATION. 5. CURRENT UP TO 85 AMPS DEPENDING ON WIRE SIZE & PAD DESIGN. 6. WAVE SOLDERABLE (THT) OR SOLDER PASTE SOLDERABLE (SMT). 7. SEE ADDITIONAL SPEC SHEETS FOR PAD DESIGN. 8. ALL ASSUMPTIONS TO BE TESTED BY CUSTOMER DUE TO MANY VARIATIONS IN IMPLEMENTATIONS. 9. LOW RESISTANCE.

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GENERAL TOLERANCES
±.015 (±0.038)

MATERIAL: **6061-T6**
XBXA-PCB-45

FINISH:
SEE NOTE

INTERNATIONAL HYDRAULICS, INC.

TITLE:
B6A-PCB-45-XX (SALES)

SCALE: DRAWN BY:
3:1 CDMR

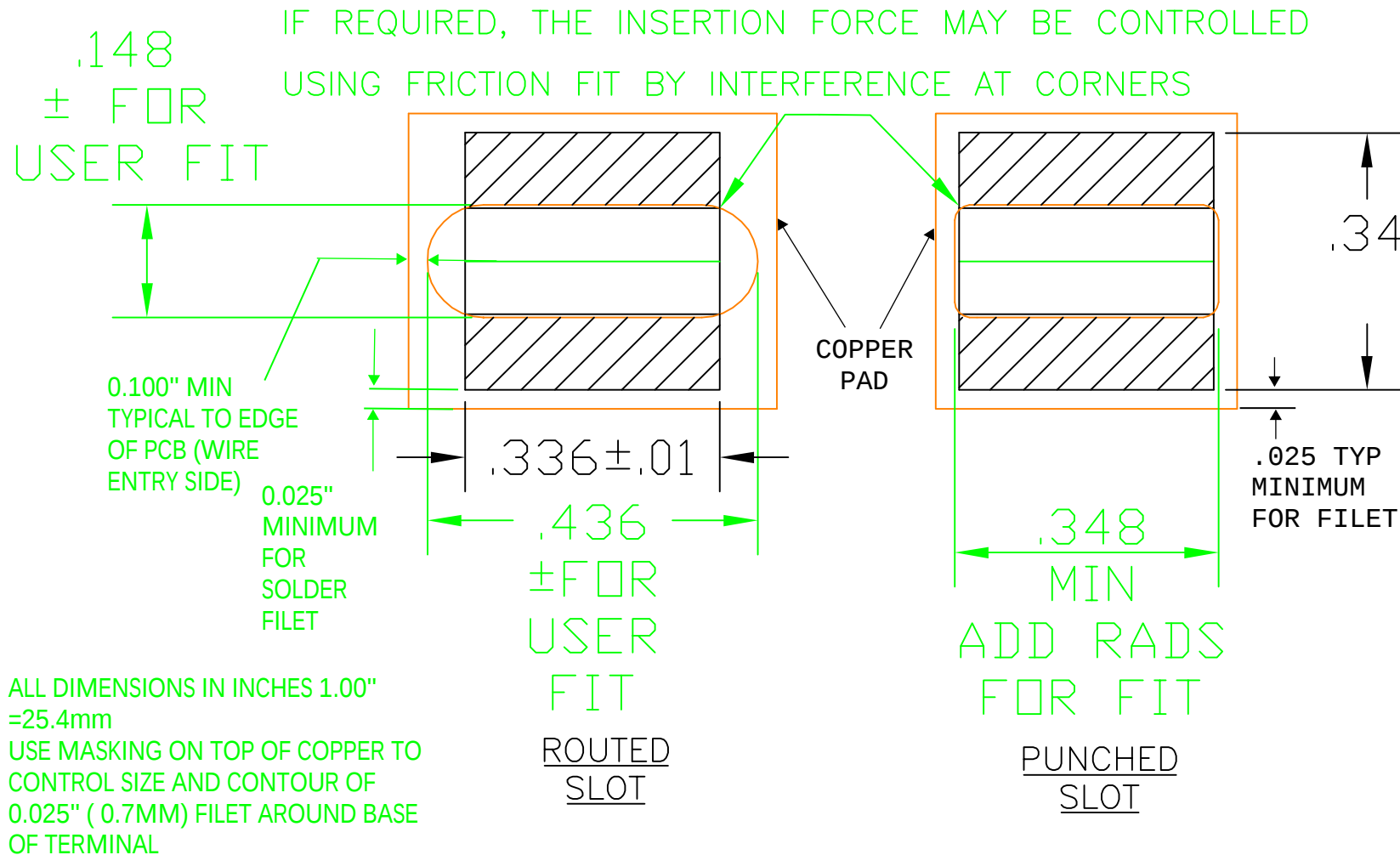
DWG NO.:
B6A-PCB-45-XX(SALES)

DATE:
July 30 2014

SALES PRINT -NOT FOR
MFG.

REV:
2a

PAGE 1 RECOMMENDED PCB THICKNESS .06" **MIN.** PLATED VIAS, DOUBLE SIDED, DO TORQUE TEST TO ENSURE YOUR SELECTED UL WIRE SIZE SCREW TORQUE REQUIREMENTS & PULL OUTS ARE MET FOR ON BOARD TESTING, AVOID SLOTS TOO NEAR TO BOARD EDGE, SUITABLE FOR WAVE SOLDER WITH SAC SOLDER, PREFLUX AND PREHEAT, SEE TYPICAL WAVE SOLDER PROFILE, AS TOO MANY VARIABLES ARE IN PLAY WITH TYPE OF BOARD AND TEMPERATURE RISE CHOSEN BY DESIGNER ALL DESIGN ASPECTS NEED TO BE TESTED FOR EACH APPLICATION BY USER.

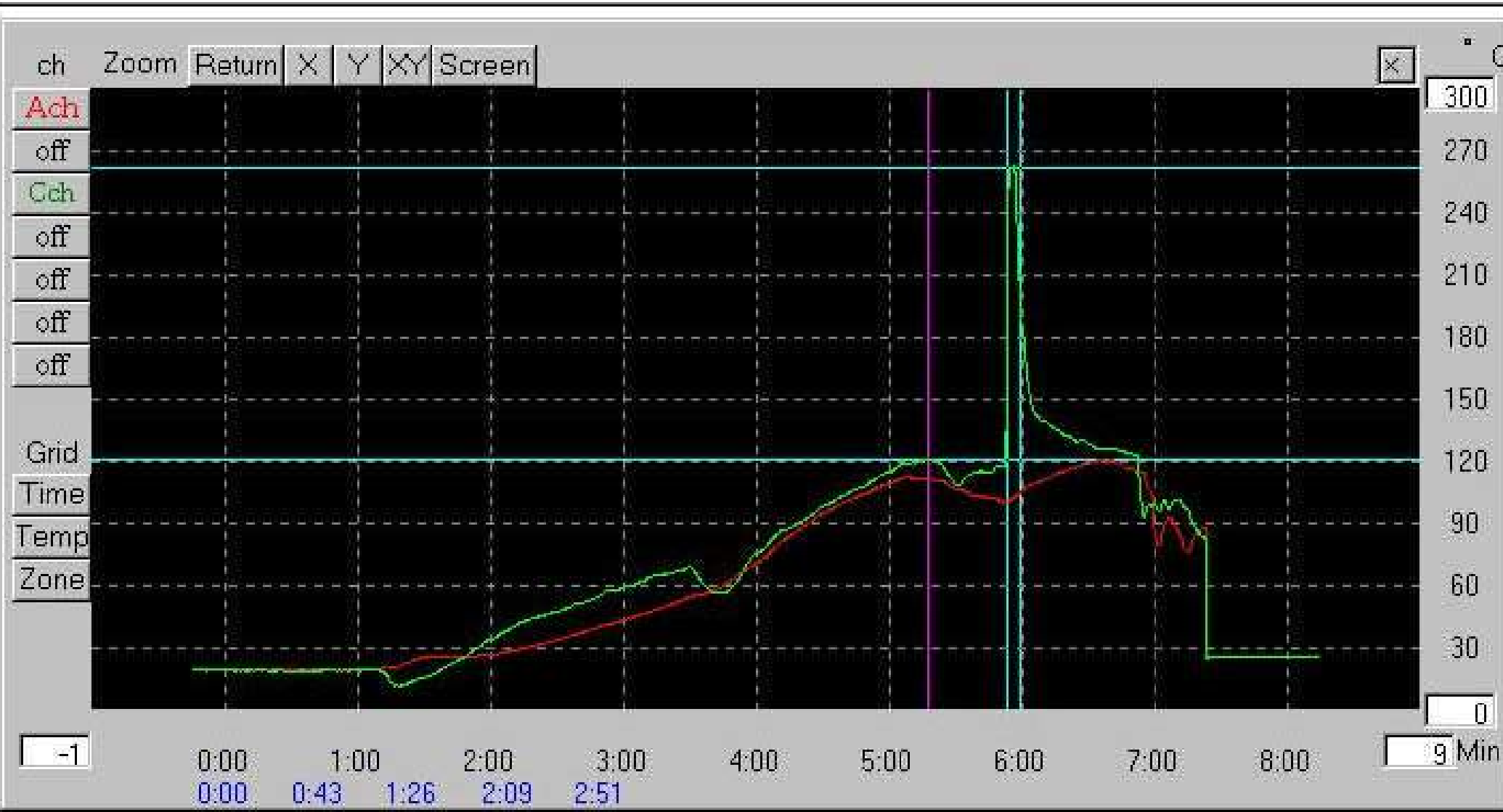


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FOR FURTHER INFORMATION ON THE PROPER USE OF THIS PRODUCT IN SPECIFIC APPLICATIONS SEE
<http://www.ihiconnectors.com/GuideToFlexFlexibleFineStrandedWireCableMechanicalLugsFAQ.html>
http://www.ihiconnectors.com/High_Amp_Wide_Trace_PCB_Wire_Connection.html
<http://www.ihiconnectors.com/Technical-Data-Installation.htm>

SOLDER FOOT PRINT FOR IHI B6A-PCB-XX, B6A-NH-PCB-XX, & B6A-PCB-45-XX

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NOTES ON FOOTPRINT LAYOUTS IN SMT MODE

IHI Connectors ® Mentor, Ohio, USA



The typical edge fillet on the IHI Solderable terminal in SMT mode is about .025" rad. (varies with amount of solder/paste used) so we suggest that the copper pad showing through the masking would be .050" total wider than the physical contact footprint to accommodate the .025" all around.

The exposed pad could be larger but there would increasingly more chance that it can float around as the exposed area gets larger. Smaller pads would restrict the amount of solder fillet around the SMT component which reduces the strength of the soldered interface somewhat and may reduce the opportunity to see a healthy looking fillet as a useful visual guide to a well wetted soldered joint.

The actual full foil size, under the masking would be as large as possible and as needed to carry the current and provide cooling.

You should test the twist off torque on an adequate number of samples to ascertain the safe amount of torque for the tightening of the screw onto the ring lug for the process you have approved your CM to use. .

Taking measurements of "twist torque to failure" will give you an idea of the head room that you have over the recommended user torque for the clamping screw.

The result tends to vary by solder type and methods and levels of porosity (gas bubbles) in the soldered interface. It is good to control all of that closely, so that you get consistent results at your third party contract house. Some solder / flux types are more prone to voids than others.

All application need to be thoroughly tested by customers for mounting strength and high cycle degradation of the soldered joint and foil bonds on the clients chosen PCB construction and operating temperatures.

To be read in conjunction with " PCB dos and don'ts guide" and "SMT guide" at links below:

<http://www.lugsdirect.com/SMT-Surface-Mount-Technology-PrintedCircuitBoard-PCB-WireTerminalLugs-IHI.html>

<http://www.lugsdirect.com/High Amp Wide Trace PCB Wire Connection.html>



23 January 1998

Best wishes for the New Year! This past year has been very successful for Morningstar, as we have now shipped over 50,000 of our ProStar and SunSaver controllers. We wish to thank you for your interest in our controllers, and we look forward to continued success in 1998.

Enclosed for your review is an Accelerated Reliability Testing Report.

Morningstar recently completed highly accelerated testing of the ProStar and SunSaver controllers. Both controllers survived the testing with remarkable success:

	<u>ProStar</u>	<u>SunSaver</u>
<u>Operating Limits:</u>	-50°C (LCD) -90°C (no LCD) +95°C 45 Grms	< -100°C > +120°C > 50 Grms
<u>Destruct Limits:</u>	< -100°C +120°C 50 Grms	< -100°C > +120°C > 50 Grms

Since these are first generation products, it is especially important to stress test the limits of the designs for future models. We plan to introduce several new controllers in 1998. This testing identifies areas of the designs that can be upgraded to further expand the safety margins for reliability and durability in the field.

Equally important, we can also have the confidence that our second generation controllers will equal or exceed the success we have had with our first controller designs.

Best regards,

A handwritten signature in dark ink, appearing to read 'Lee S. Gordon'.

Lee S. Gordon



ACCELERATED RELIABILITY TESTING
-- ProStar and SunSaver Controllers: July 1997 --

1. Objective

Developmental HALT (Highly Accelerated Life Testing) is an intensive process to uncover design and manufacturing weaknesses in an electronic product. The test units are subjected to progressively higher stress levels by extreme temperature transitions, vibration, and combined environments. The intent is to stress the product well beyond normal operating conditions and determine the operating and destruct limits of the product.

As each failure occurs, the failure is repaired so testing can continue to higher stress levels. This allows a sequence of failures to occur up to the extreme stress limits.

The ultimate goal is to determine the root cause of each failure, and then correct each failure mode. This process can allow the product to reach the fundamental limit of its technology. This will dramatically reduce failures in the field due to aging or other stressful operating conditions.

2. Test Procedure

ProStar and SunSaver controllers were tested by QualMark Corporation in July 1997. A Morningstar engineer was present to repair failures and support the testing. Sandia National Labs also provided support for this testing.

Before beginning the HALT testing, four controllers were subjected to HAST testing. The HAST process is a relatively new test program, and it creates a high-temperature, high-pressure and high-humidity environment in a QualMark test chamber. Two ProStars and two SunSavers were placed in the chamber and powered up without loads for 200 hours.

For the HALT testing, three ProStar controllers and two SunSaver controllers were tested. To find the operating and destruct limits

of the ProStar and SunSaver designs, four groups of tests were done. These tests included the following:

- Thermal Step Stress
- Rapid Thermal Transitions
- Vibration Step Stress
- Combined Environment

Each controller on test was operated under load. The PV input was connected to a dc power supply at 13.5 volts, and the output was loaded between 2 and 10 amps.

Each ProStar was subjected to 3 of the 4 HALT tests, and each SunSaver was subjected to all 4 tests.

3. HAST Test

The test units are stressed to failure in an accelerated time under the following conditions:

- 110°C temperature
- 85% relative humidity
- 1.20 atmospheric pressure
- 200 hours duration

HAST testing duplicates failure modes that result from the standard 85/85 testing, but the tests take far less time.

Overall the test controllers performed very well, with 3 of the 4 units still functional after the test. Although some components cracked or failed, this was expected. While the bare board assemblies only suffered minor damage, the value of the conformal coating protection was evident.

4. Thermal Step Stress Test

Each test controller was subjected to cold thermal steps by decreasing the temperature from +20°C to -100°C in 10°C increments. The hot thermal steps range from +40°C to +120°C with the same increments. The controllers were operated through a full functional test sequence at each temperature.

The controllers passed each temperature step with the following exceptions or comments:

	<u>ProStar</u>	<u>ProStar-LCD</u>	<u>SunSaver</u>
- 60°C	pass	fail ¹	pass
- 100°C	pass	fail ²	pass
+ 60°C	pass ³	pass	pass
+ 100°C	pass	fail ⁴	pass
+ 120°C	pass	fail ⁵	pass

Notes:

- 1 - The LCD display was not visible
- 2 - The LCD meter amplifier became unstable
- 3 - The ProStar overtemperature protection circuit was manually disabled to continue the tests
- 4 - The LCD display was not legible
- 5 - The LCD driver was damaged

5. Rapid Thermal Transition Test

Each controller was subjected to 5 rapid temperature cycles from -100°C to +100°C. The rate of temperature change was 65°C per minute (i.e. 200°C temperature change in 3 minutes). The units remained at each temperature extreme for 10 minutes.

All of the test units passed with no problems or comments with one exception. The exception was a ProStar meter unit that failed after the 4th cycle to +100°C when the red disconnect button case softened and stuck in the disconnect position during the function test check. The button released and continued to function normally during the next cold cycle.

6. Vibration Step Stress Test

Each controller was subjected to vibration steps that began at 5 Grms and increased in 5 Grms increments up to 50 Grms. Each vibration step was continued for 10 minutes. All testing was done at 20°C. Vibration was applied in 6 axes (rotational / directional).

The SunSaver units passed all the tests with no problems. The ProStar units passed without problem up to 50 Grms. At 50 Grms the following failures occurred:

- 2 ProStar units had FET leads break

- 1 ProStar LCD capacitor had a lead break

The 50 G forces imposed on the controllers were at the limit of the test equipment.

7. Combined Environment Test

After completing the tests above, each unit was finally subjected to rapid temperature cycles from -100°C to +100°C combined with vibration. The thermal transitions were very fast (3 minutes), and at the end of each thermal cycle the vibration was increased by 10 Grms for a 10 minute interval.

This resulted in 6 thermal cycles, each with a 200°C temperature range, and vibration levels increasing from 10 Grms up to 50 Grms.

There were some additional FET and capacitor failures on the ProStar. The SunSaver passed all the tests.

8. Summary

The SunSaver and ProStar controllers (both first generation designs) passed the HAST and HALT testing with remarkable success. The test results far exceeded the best expectations of Morningstar.

The controller models as tested (i.e. before any design modifications or improvements) were given the following Operating and Destruct Limits by QualMark:

	<u>ProStar</u>	<u>SunSaver</u>
<u>Operating Limits:</u>	-50°C (LCD) -90°C (no LCD) +95°C 45 Grms	< -100°C > +120°C > 50 Grms
<u>Destruct Limits:</u>	< -100°C +120°C 50 Grms	< -100°C > +120°C > 50 Grms

The "<" and ">" signs indicate that the rating exceeds the limits of the test setup and equipment.

Some basic design upgrades will significantly extend the operating limits of the ProStar controllers. The purpose of this HAST/HALT testing is to identify areas of the design that can be modified to increase the limits of the device. Morningstar will address the following areas for the second generation ProStar design:

- replace leaded parts with surface mount parts
- modify the LCD meter circuit (an upgraded and more simple meter circuit design has been in progress)
- upgrade the red disconnect button
- replace the battery select pin with a rotary switch (one pin was damaged in the vibration testing, and this replacement had already been identified)
- upgrade the calibration process (the HAST testing caused a small drift, and upgraded methods of calibration have been identified)

Morningstar's goal is to expand the operating and destruct limits of the company's products with continuous design improvements. Even though the first generation designs provided very high limits, expanding these limits will further reduce the effects of aging and ensure very high reliability margins over a long period of time.